

Attorney's Docket No.: 14157-013001 / P1P2003173US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Masayuki Tobita et al.

Art Unit : Unknown

Serial No.: 10/685,905

Examiner: Unknown

Filed

: October 14, 2003

Title

: THERMALLY-CONDUCTIVE EPOXY RESIN MOLDED ARTICLE AND

METHOD OF MANUFACTURING THE SAME

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Applicants disclose the documents listed on the attached form PTO-1449, copies of which are enclosed. Also enclosed is a copy of a search report dated December 30, 2003, issued in corresponding European Application EP 03 25 6089. The disclosed documents were first cited in any communication from a foreign patent office in a counterpart application not more than three months prior to the filing of this statement.

This statement is also being filed before the receipt of a first Office action on the merits. Please apply any charges to Deposit Account No. 06-1050.

Respectfully submitted,

3-10-04

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U.S. Department of Commerce Patent and Trademark Office

Attorney's Docket No. 14157-013001

Application No. 10/685,905

Information Disclosure Statement
by Applicant
(Use several sheets if necessary)

Masayuki Tobita et al.

Filing Date

Applicant

Group Art Unit

§1.98(b))

October 14, 2003

| U.S. Patent Documents | | | | | | | |
|-----------------------|--------|-----------|-------------|--------------------|-------|----------|----------------|
| | | | | nt Documents | | | |
| Examiner | Desig. | Document | Publication | | | | Filing Date |
| Initial | ID | Number | Date | Patentee | Class | Subclass | If Appropriate |
| | AA | 5,391,651 | 02/21/95 | Earls et al. | 525 | 526 | |
| | AB | 5,266,660 | 11/30/93 | Hefner, Jr. et al. | 525 | 481 | |
| | AC | 4,962,160 | 10/09/90 | DeMartino et al. | 525 | 404 | |
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| | Foreign Patent Documents or Published Foreign Patent Applications | | | | | | | |
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| Examiner | Desig. | Document | Publication | Country or | , | | Trans | slation |
| Initial | ID | Number | Date | Patent Office | Class | Subclass | Yes | No |
| | AL | | | | | - | | |
| | AM | | | | | | | |
| | AN | | | | | | | |
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| | Other Documents (include Author, Title, Date, and Place of Publication) | | | | |
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| EXAMINER: Initials citation considered. Draw line through citation if no | t in conformance and not considered. Include copy of this form with |
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